

Data Sheet

November 2013

30 A, 400 V - 600 V, Hyperfast Diode

Description

The RHRG3040, RHRG3060 is a hyperfast diode with soft recovery characteristics. It has the half recovery time of ultrafast diodes and is silicon nitride passivated ionimplanted epitaxial planar construction. These devices are intended to be used as freewheeling/ clamping diodes and diodes in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Ordering Information

PART NUMBER	PACKAGE	BRAND
RHRG3040	TO-247	RHRG3040
RHRG3060	TO-247	RHRG3060

NOTE: When ordering, use the entire part number.

Symbol



Features

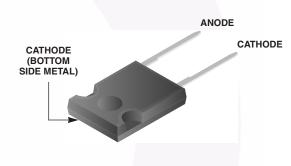
- Hyperfast Recovery t_{rr} = 45 ns (@ I_F = 30 A)
- Max Forward Voltage, V_F = 2.1 V (@ T_C = 25°C)
- 400 V, 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

Applications

- · Switching Power Supplies
- Power Switching Circuits
- General Purpose

Packaging

JEDEC STYLE TO-247



Absolute Maximum Rating T_C = 25°C, Unless Otherwise Specified

	RHRG3040	RHRG3060	UNIT	
Peak Repetitive Reverse Voltage	400	600	V	
Working Peak Reverse Voltage	400	600	V	
DC Blocking Voltage V _R	400	600	V	
Average Rectified Forward Current $I_{F(AV)}$ ($T_C = 120^{\circ}C$)	30	30	Α	
Repetitive Peak Surge CurrentIFRM (Square Wave, 20 kHz)	70	70	Α	
Nonrepetitive Peak Surge Current	325	325	Α	
Maximum Power Dissipation	125	125	W	
Avalanche Energy (See Figures 10 and 11)	20	20	mJ	
Operating and Storage Temperature	-65 to 175	-65 to 175	οС	

Electrical Specification $T_C = 25^{\circ}C$, Unless Otherwise Specified

			RHRG3040		RHRG3060			
SYMBOL	TEST CONDITION	MIN	ТҮР	MAX	MIN	TYP	MAX	UNIT
V _F	I _F = 30 A	-	-	2.1	-	-	2.1	V
	$I_F = 30 \text{ A}, T_C = 150^{\circ}\text{C}$	-	-	1.7	-	-	1.7	V
I _R	V _R = 400 V	-	-	250	-	-	-	μА
	V _R = 600 V	-	-	-	-	-	250	μΑ
	$V_R = 400 \text{ V}, T_C = 150^{\circ}\text{C}$	-	-	1.0	-	-	-	mA
	$V_R = 600 \text{ V}, T_C = 150^{\circ}\text{C}$	-	-	-	-	-	1.0	mA
t _{rr}	$I_F = 1 \text{ A}, dI_F/dt = 200 \text{ A/}\mu\text{s}$	-	-	40	-	-	40	ns
	I _F = 30 A, dI _F /dt = 200 A/μs	-	-	45	-	-	45	ns
ta	$I_F = 30 \text{ A}, dI_F/dt = 200 \text{ A/}\mu\text{s}$	-	22	-	-	22	-	ns
t _b	I _F = 30 A, dI _F /dt = 200 A/μs	-	18	-	-	18	-	ns
Q _{rr}	I _F = 30 A, dI _F /dt = 200 A/μs	-	100	-	-	100	-	nC
СЈ	V _R = 10 V, I _F = 0 A	-	85	-	-	85	-	pF
$R_{ heta JC}$		-	-	1.2	-	-	1.2	°C/W

DEFINITIONS

 V_F = Instantaneous forward voltage (pw = 300 μ s, D = 2%).

I_R = Instantaneous reverse current.

 T_{rr} = Reverse recovery time (See Figure 9), summation of $t_a + t_b$.

 t_a = Time to reach peak reverse current (See Figure 9).

 t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 9).

 Q_{rr} = Reverse recovery charge.

C_J = Junction Capacitance.

 $R_{\theta JC}$ = Thermal resistance junction to case.

pw = Pulse width.

D = Duty cycle.

Typical Performance Curves

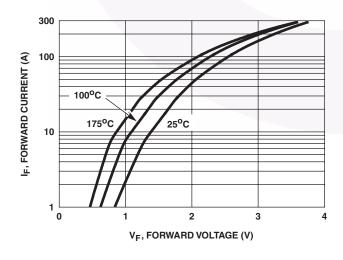


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

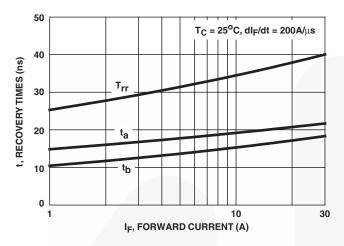


FIGURE 3. T_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

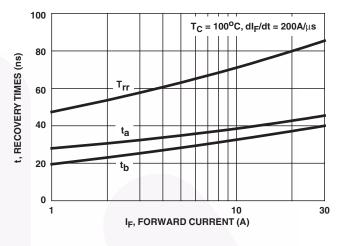


FIGURE 4. T_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

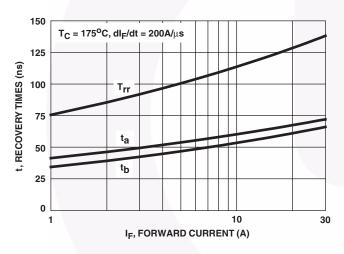


FIGURE 5. T_{rr} , t_a AND t_b CURVES vs FORWARD CURRENT

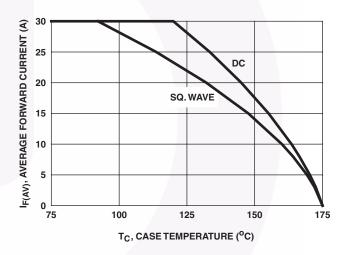


FIGURE 6. CURRENT DERATING CURVE

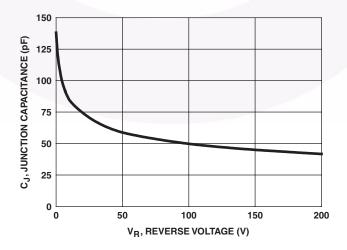


FIGURE 7. JUNCTION CAPACITANCE vs REVERSE VOLTAGE

Test Circuits and Waveforms

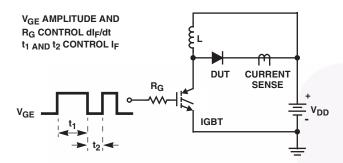


FIGURE 8. T_{rr} TEST CIRCUIT

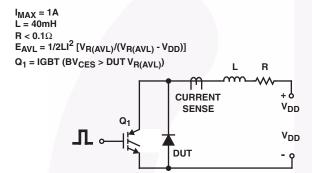


FIGURE 10. AVALANCHE ENERGY TEST CIRCUIT

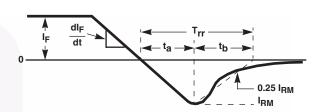


FIGURE 9. T_{rr} WAVEFORMS AND DEFINITIONS

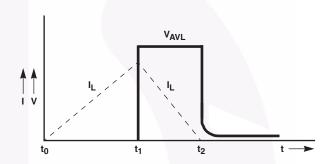


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

Mechanical Dimensions

TO247-2L

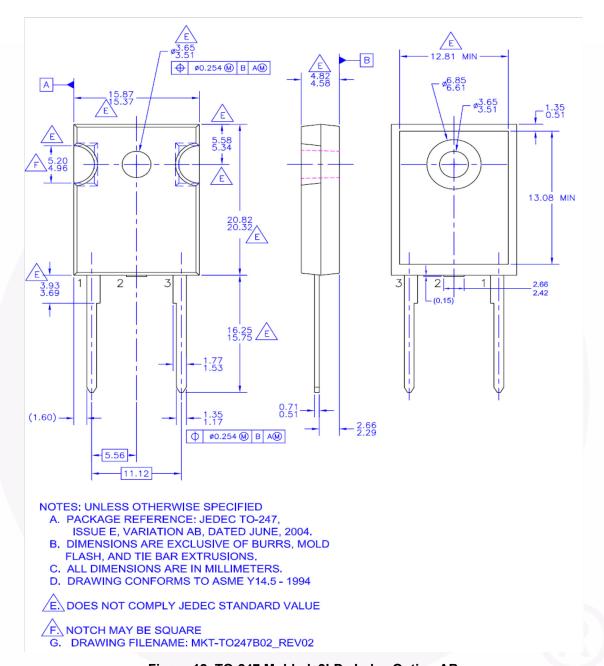


Figure 12. TO-247, Molded, 2LD, Jedec Option AB

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